

SANYO Semiconductors DATA SHEET

FTD2017M—

N-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · 2.5V drive.
- · Mount height 1.1mm.
- · Composite type, facilitating high-density mounting.
- · Drain common specifications.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ID		6	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	40	А
Allowable Power Dissipation	PD	When mounted on ceramic substrate (1000mm²X0.8mm) 1unit	1.2	W
Total Dissipation	PT	When mounted on ceramic substrate (1000mm²X0.8mm)	1.25	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions		Ratings		Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =20V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} = ±8V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _D S=10V, I _D =1mA	0.5		1.3	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =6A	5	8.5		S

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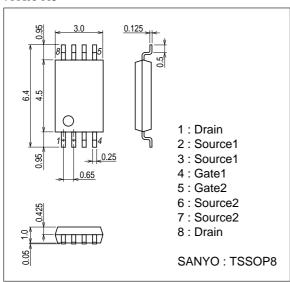
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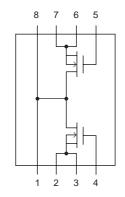
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Static Drain-to-Source On-State Resistance	RDS(on)1	ID=6A, VGS=4.5V	13	17	23	mΩ
	R _{DS} (on)2	I _D =6A, V _{GS} =4V	14	18	24	mΩ
	R _{DS} (on)3	I _D =3A, V _{GS} =3.1V	15	19	30	mΩ
	RDS(on)4	ID=3A, VGS=2.5V	15.4	20	33	mΩ
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		930		ns
Rise Time	t _r	See specified Test Circuit.		1460		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		6400		ns
Fall Time	tf	See specified Test Circuit.		3040		ns
Total Gate Charge	Qg	V _{DS} =10V, V _{GS} =4.5V, I _D =6A		10		nC
Gate-to-Source Charge	Qgs	V _{DS} =10V, V _{GS} =4.5V, I _D =6A		2		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =10V, V _{GS} =4.5V, I _D =6A		2.5		nC
Diode Forward Voltage	V _{SD}	IS=6A, VGS=0V		0.8	1.2	V

Package Dimensions

unit : mm (typ) 7006A-005

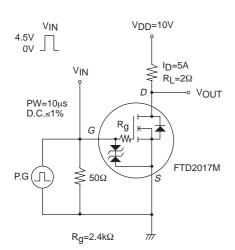


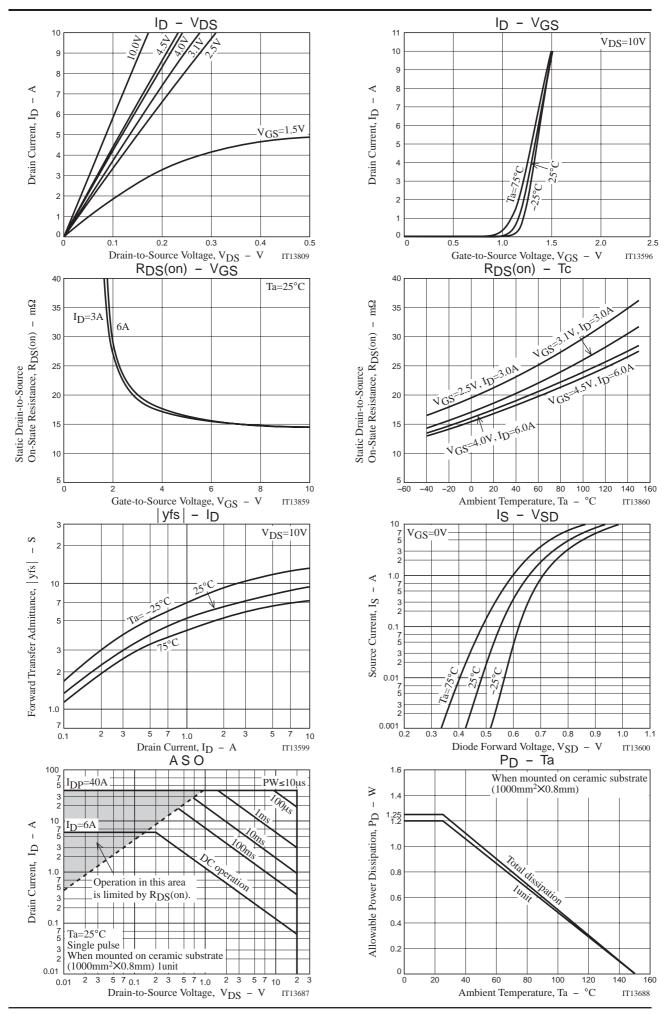
Electrical Connection



1 : Drain 2 : Source1 3 : Source1 4 : Gate1 5 : Gate2 6 : Source2 7 : Source2 8 : Drain

Switching Time Test Circuit





Note on usage: Since the FTD2017M is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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